HSEC8-149-01-L-DV-A



(0,80mm) .0315" **HSEC8-DV SERIES**

VERTICAL EDGE RATE™CARD SOCKET

SAMTEC

- Board lock option
- · Latch option

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?HSEC8-DV

Insulator Material: Black Liquid Crystal Polymer Contact: ReCu.

Plating: Au or Sn over 50μ" (1,27µm) Ni **Current Rating:** 3.1A @ 30°C Temperature Rise (See website for details)

Operating Temp: Card Insertion Depth: (3,15mm) .125" nominal **RoHS Compliant:**

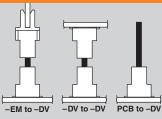
Processing:

Lead-Free Solderable:

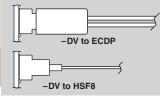
SMT Lead Coplanarity: (0,10mm) .004" max (10-60)

Mates with: 1,60mm thick cards, ECDP, HSC8, HSF8 0,80mm HSEC8 Rated @ 3dB Insertion Loss 7,98mm Stack Height 8 GHz / 16 Gbps Single-Ended Signaling Alignment Differential Pair Signaling 10.5 GHz / 21 Gbps Pins For complete test data go to www.samtec.com?HSEC8-DV or contact sig@samtec.com

BOARD-TO-BOARD APPLICATIONS



HIGH SPEED CABLE & **FLEX APPLICATIONS**



STANDARD & CUSTOM CARDS AVAILABLE

- Standard high speed interface cards for 19mm, 25mm & 30mm mated heights, single-ended & differential applications. See HSC8 Series.
- Custom cards for low-cost stack height customization
- · Samtec supplied card layout/artwork to make your own
- cards Specialty card

APPLICATION SPECIFIC OPTION

Guide rails and pass-through options. Call Samtec.

Note: Some lengths, styles and options are non-standard, non-returnable.

POSITIONS HSEC8 PER ROW

CARD THICKNESS

-01

(1,60mm) .062"

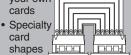
thick card

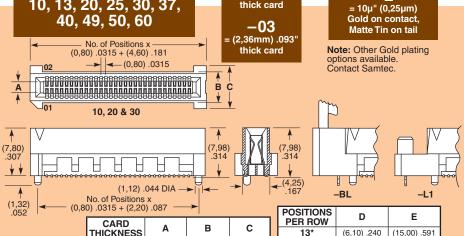
PLATING OPTION

OTHER OPTION

10, 13, 20, 25, 30, 37, 40, 49, 50, 60







| | -01 | (1,75) .070 | (5,60) .220 | (7,00) .276 | |
|---|-----|-------------|-------------|-------------|--|
| | -03 | (2,54) .100 | (6,39) .252 | (7,79) .307 | |
| No. of Positions x (0,80) .0315 + (7,80) .307 | | | | | |
| 02 D - | | - | | | |
| ###################################### | | | | | |
| 01 | | | | | |

(6,10) .240 (15,00) .591 13* 25 (6,10) .240 (24,60) .969 37* (18,10) .713 (34,20) 1.346 (18,90) .744 (36,60) 1.441 40 49 (22,90) .902 (43,80) 1.724 (22,90) .902 (44,60) 1.756 50 60 (26,90) 1.059 (52,60) 2.071

Positions where no dimensions are given do not have keying feature *Mates with ECDP Series

(5,50mm) .217" DIA Polyimide Film Pick & Place Pad

–TR

= Tape & Reel **Packaging**

-L1

= Latching Option (For use with ECDP.) (13, 25, 37, 49 only)

–BL

Board Locks (40, 50, 60 only) Other sizes available Contact Samtec.)

> _WT = Weld tab

| CONNECTOR | CABLE* |
|-----------|---------|
| HSEC8-113 | ECDP-08 |
| HSEC8-125 | ECDP-16 |
| HSEC8-137 | ECDP-24 |
| HSEC8-149 | ECDP-32 |

Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM